



Product Change Notification

Change Notification #: 118500-00
Change Title: Intel® Server Board M10JNP2SB,
PCN 118500-00, Label,
Label updates
Date of Publication: September 15, 2021

Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	September 30, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing changes on the Intel® Server Board M10JNP2SB and the packaging carton boxes.

1. Adding UKCA Logo and updating the NEMKO and Intel logo on the board

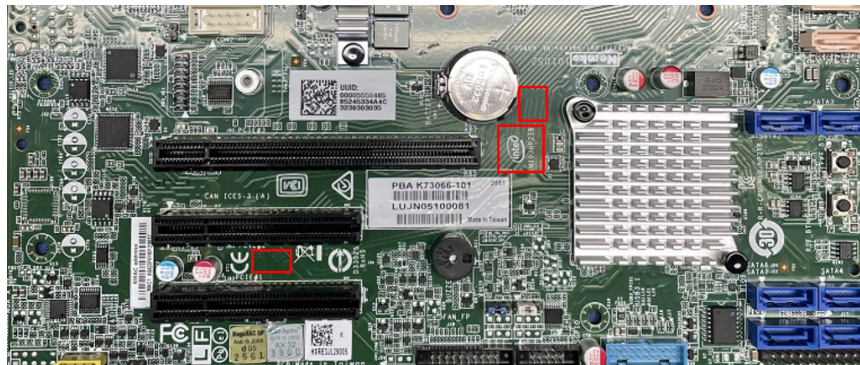


Image 1. Board before the change

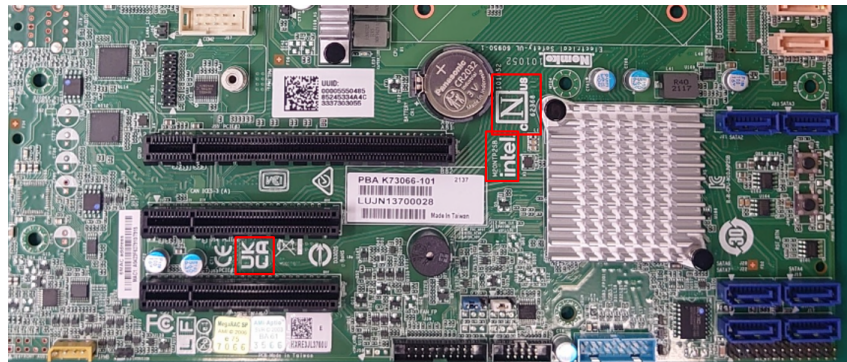


Image 2. Board after the change

2. Adding UKCA Logo and updating the NEMKO logo on the single box label



Image 3. Box label before the change

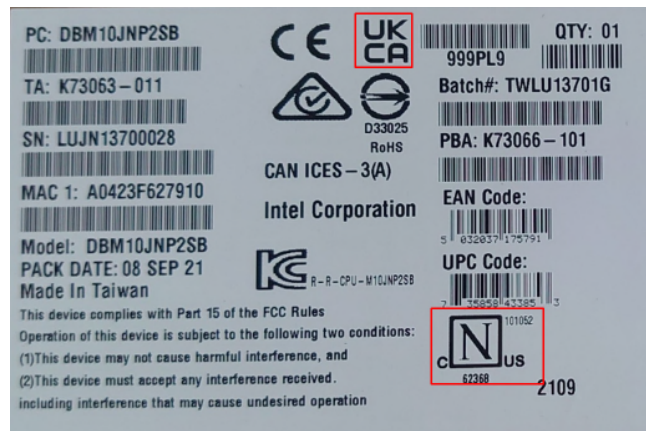


Image 4. Box label after the change

3. Adding UKCA Logo and updating the NEMKO logo on the multi shipping box label

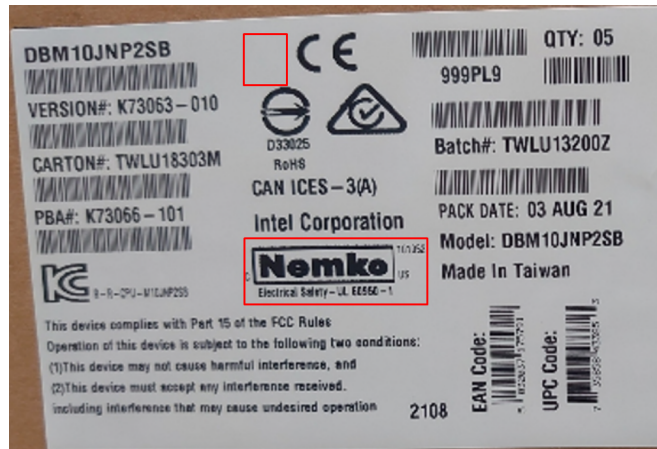


Image 5. Multi shipping box label before the change

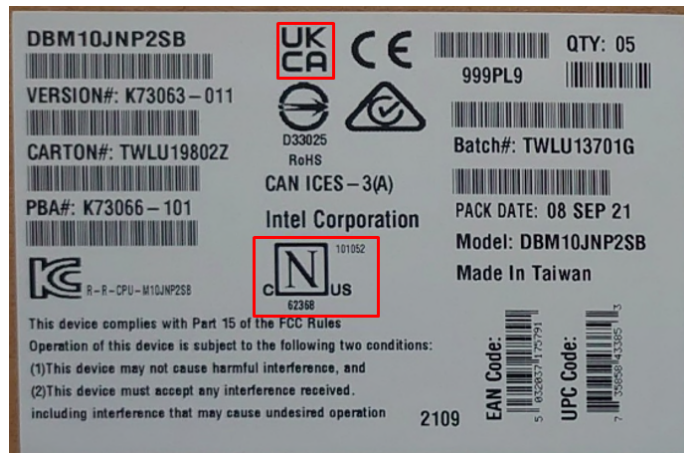


Image 6. Multi shipping box label after the change

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Server Board M10JNP2SB, Disti 5 pack	DBM10JNP2SB	999PL9	K73063-010	K73063-011

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
September 15, 2021	00	Originally Published PCN



Product Change Notification

118500-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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